NPN 3.0A 50V Power Transistor

Datasheet

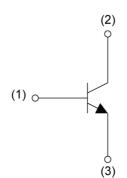
### **AEC-Q101 Qualified**

Parameter	Value	
V <sub>CEO</sub>	50V	
Ic	3A	

# DPAK TO-252

#### Features

- 1) Suitable for Power Driver.
- 2) Complementary PNP Types: 2SAR573D3 FRA.
- 3) Low  $V_{CE(sat)}$   $V_{CE(sat)}$ =350mV(Max.). ( $I_C/I_B$ =1A/50mA)



## ●Inner circuit

Outline

- (1) Base(2) Collector
- (3) Emitter

## Application

LOW FREQUENCY AMPLIFIER

## Packaging specifications

Part No.	Package	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
2SCR573D3 FRA	TO-252 (DPAK)	TL	330	16	2500	2SCR573D3

# ● Absolute maximum ratings (T<sub>a</sub> = 25°C)

Parameter	Symbol	Values	Unit
Collector-base voltage	$V_{CBO}$	50	V
Collector-emitter voltage	V <sub>CEO</sub>	50	V
Emitter-base voltage	$V_{EBO}$	6	V
Collector ourse of	I <sub>C</sub>	3	Α
Collector current	I <sub>CP</sub> *1	6	Α
Power dissipation	P <sub>D</sub> *2	10	W
Junction temperature	T <sub>j</sub>	150	°C
Range of storage temperature	T <sub>stg</sub>	-55 to +150	°C

## ● Electrical characteristics (T<sub>a</sub> = 25°C)

Parameter	Symbol	Conditions	Values			Lloit	
raiainetei	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Collector-base breakdown voltage	BV <sub>CBO</sub>	I <sub>C</sub> = 100μA	50	-	-	V	
Collector-emitter breakdown voltage	BV <sub>CEO</sub>	I <sub>C</sub> = 1mA	50	-	-	V	
Emitter-base breakdown voltage	BV <sub>EBO</sub>	I <sub>E</sub> = 100μA	6	-	-	V	
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> = 50V	-	-	1	μA	
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> = 4V	-	-	1	μA	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> = 1A, I <sub>B</sub> = 50mA	-	130	350	mV	
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> = 3V, I <sub>C</sub> = 100mA	180	-	450	-	
Transition frequency	f <sub>T</sub> *3	$V_{CE} = 10V, I_{E} = -600mA,$ f = 100MHz	-	320	-	MHz	
Output capacitance	C <sub>ob</sub>	$V_{CB} = 10V$ , $I_E = 0A$ , $f = 1MHz$	ı	20	1	pF	
Turn-On time	t <sub>on</sub>	I <sub>C</sub> = 1.5A, I <sub>B1</sub> = 150mA,	ı	70	ı	ns	
Storage time	t <sub>stg</sub>	$I_{B2} = -150 \text{mA},$ $V_{CC} \approx 10 \text{V},$	ı	400	ı	ns	
Fall time	t <sub>f</sub>	$R_L = 6.8\Omega$ See test circuit	1	120	1	ns	

<sup>\*1</sup> Pw=10ms Single Pulse

<sup>\*2</sup> Tc=25℃

<sup>\*3</sup> Pulsed

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.1 Grounded Emitter Propagation Characteristics

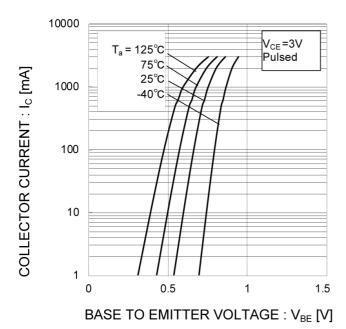
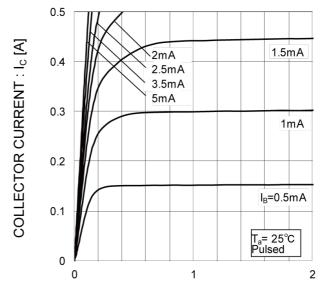


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V<sub>CE</sub> [V]

Fig.3 DC Current Gain vs. Collector Current(I)

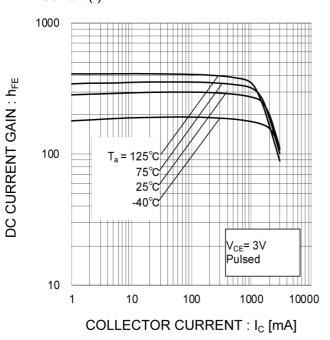
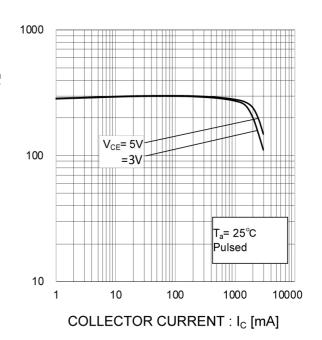


Fig.4 DC Current Gain vs. Collector Current(II)



DC CURRENT GAIN: he

## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current(I)

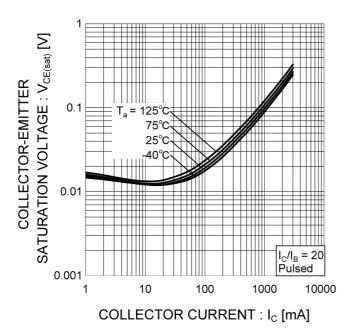


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current(II)

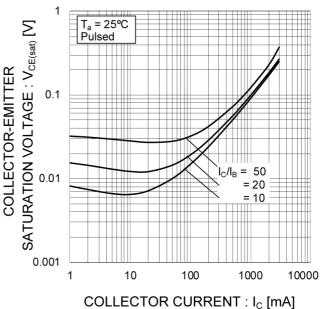


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

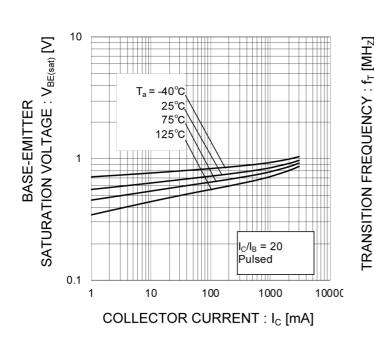
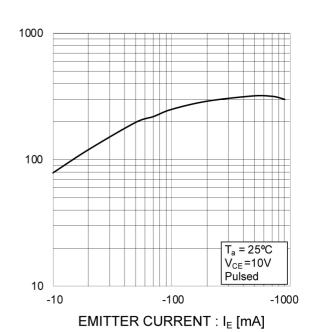


Fig.8 Gain Bandwidth Product vs. Emitter Current



## ● Electrical characteristic curves(T<sub>a</sub> = 25°C)

Fig.9 Emitter input capacitance vs.

**Emitter-Base Voltage** 

Collector output capacitance vs.

Collector-Base Voltage

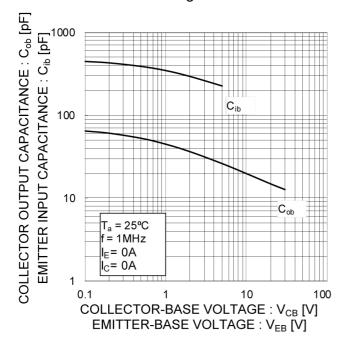
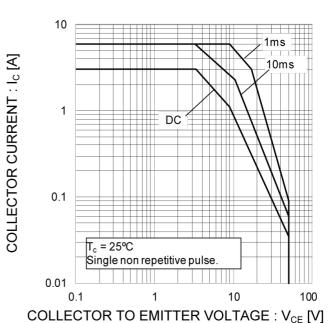
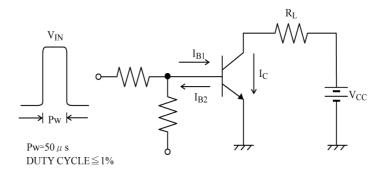
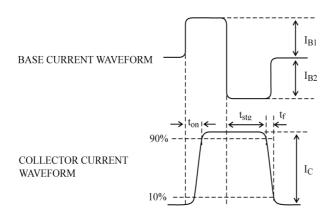


Fig.10 Safe Operating Area

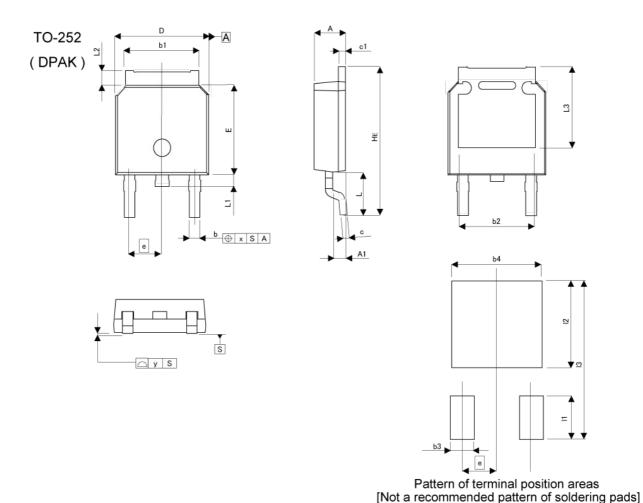


#### SWITCHING TIME TEST CIRCUIT





## Dimensions



MILIMETERS **INCHES** DIM MIN MAX MIN MAX 0.083 2.10 2.30 0.091 Α A1 0.70 1.10 0.028 0.043 b 0.65 0.85 0.026 0.033 0.213 5.10 0.201 5.40 b1 b2 5.10 0.201 0.40 0.60 0.016 0.024 C 0.40 0.60 0.016 0.024 c1 0.252 D 6.40 6.80 0.268 е 6.00 0.236 0.252 6.40 E HE 9.50 10.50 0.374 0.413 0.114 0.70 0.028 0.035 L1 0.90 0.70 0.028 0.051 L2 1.30 L3 0.10 0.004 Х 0.10 0.004

DIM	MILIM	ETERS	INCHES		
DIIVI	MIN	MAX	MIN	MAX	
b3	-	1.10		0.043	
b4	-	5.40	7 <del>-</del> 1	0.213	
l1	2	2.90	-	0.114	
12	-	5.50	-	0.217	
13	2	10.50	-	0.413	

Dimension in mm/inches



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  - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
  - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl<sub>2</sub>, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, and NO<sub>2</sub>
  - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
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  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
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- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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  - [b] the temperature or humidity exceeds those recommended by ROHM
  - [c] the Products are exposed to direct sunshine or condensation
  - [d] the Products are exposed to high Electrostatic
- Even under ROHM recommended storage condition, solderability of products out of recommended storage time period
  may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is
  exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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